



5364X Series

Single Color $\phi 5$ Round Shape Type

Features

Package	$\phi 5$ Round shape type, MBG,MPG : Pale Green Clear epoxy MAY : Pale Yellow Clear epoxy MAA : Pale Orange Clear epoxy MVR,BR,MPR : Pale Red Clear epoxy	
Product features	• Outer Dimension $\phi 5$ Round shape type • Operation temperature range. Storage Temperature : $-30^{\circ}\text{C} \sim 100^{\circ}\text{C}$ Operating Temperature : $-30^{\circ}\text{C} \sim 85^{\circ}\text{C}$ • Lead-free soldering compatible • RoHS compliant	
Dominant wavelength	Green : 558nm (MBG), 567nm (MPG) Yellow : 590nm (MAY) Orange : 606nm (MAA) Red : 624nm (MVR) 647nm (BR) 630nm (MPR)	
Half Intensity Angle	MBG : 28 deg., MPG : 24 deg. MAY,MPR : 25 deg., MVR, MAA : 28 deg. BR : 40 deg.	
Die materials	MBG, MPG, MPR : GaP MAY, MAA, MVR : GaAsP BR : GaAlAs	
Rank grouping parameter	Sorted by luminous intensity per rank taping	
Soldering methods	TTW (Through The Wave) soldering and manual soldering	
ESD	More than 2kV(HBM)	
Packing	Bulk : 200pcs(MIN.)	

Recommended Applications

Amusement Equipment, Electric Household Appliances, OA/FA, Other General Applications

Color and Luminous Intensity

(Ta=25°C)

Part No.	Material	Emitted Color	Lens Color		Dominant Wavelength		Luminous Intensity		
					λ d (nm)		Iv (mcd)		
					TYP.	I _F	MIN.	TYP.	I _F
MBG5364X	GaP	Green	Pale Green	Clear	558	20	20	40	20
MPG5364X	GaP	Green			567	20	50	100	20
MAY5364X	GaAsP	Yellow			590	20	40	80	20
MAA5364X	GaAsP	Orange	Pale Orange		606	20	50	100	20
MVR5364X	GaAsP	Red	Pale Red		624	20	50	100	20
BR5364X	GaAlAs	Red			647	20	60	120	20
MPR5364X	GaP	Red			630	10	5	10	10

Absolute Maximum Ratings

(Ta=25°C)

Item	Symbol	Absolute Maximum Ratings							Unit
		MBG	MPG	MAY	MAA	MVR	BR	MPR	
Power Dissipation	P_d	70	70	85	70	75	100	75	mW
Forward Current	I_F	25	25	30	25	30	50	30	mA
Pulse Forward Current ※1	I_{FRM}	60	60	75	60	75	300	75	mA
Derating (Ta=25°C or higher)	ΔI_F	0.33	0.33	0.40	0.33	0.40	0.67	0.40	mA/°C
Reverse Voltage	V_R	4	4	4	4	4	4	4	V
Operating Temperature	T_{opr}	-30~+85							°C
Storage Temperature	T_{stg}	-30~+100							°C

※1 I_{FRM} Measurement condition : Pulse Width $\leq 1ms.$, Duty $\leq 1/20$.

Electro-Optical Characteristics(MBG,MPG,MAY,MAA,MVR,BR)

(Ta=25°C)

Item	Conditions	Symbol	Characteristics							Unit
				MBG	MPG	MAY	MAA	MVR	BR	
Forward Voltage	I _F =20mA	V _F	TYP.	2.1	2.1	2.2	2.2	2.0	1.7	V
			MAX.	2.8	2.8	2.8	2.8	2.8	2.0	
Reverse Current	V _R =4V	I _R	MAX.	20	20	20	20	20	100	μ A
Peak Wavelength	I _F =20mA	λ_p	TYP.	555	560	580	605	630	660	nm
Dominant Wavelength	I _F =20mA	λ_d	TYP.	558	567	590	606	624	647	nm
Spectral Line Half Width	I _F =20mA	$\Delta \lambda$	TYP.	30	30	30	30	30	30	nm
Half Intensity Angle	I _F =20mA	2 θ 1/2	TYP.	28	28	25	25	25	40	deg.

Electro-Optical Characteristics(MPR)

(Ta=25°C)

Item	Conditions	Symbol	Characteristics		Unit
				MPR	
Forward Voltage	I _F =10mA	V _F	TYP.	2.1	V
			MAX.	2.8	
Reverse Current	V _R =4V	I _R	MAX.	20	μ A
Peak Wavelength	I _F =10mA	λ_p	TYP.	700	nm
Dominant Wavelength	I _F =10mA	λ_d	TYP.	630	nm
Spectral Line Half Width	I _F =10mA	$\Delta \lambda$	TYP.	100	nm
Half Intensity Angle	I _F =10mA	2 θ 1/2	TYP.	40	deg.

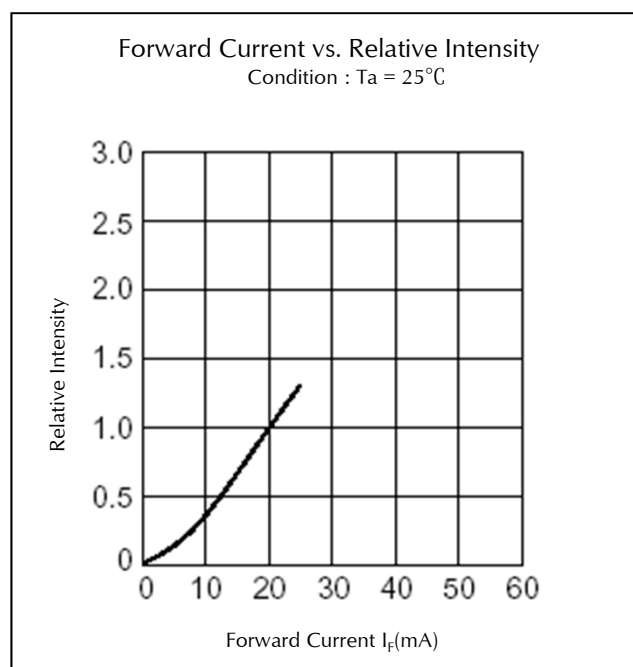
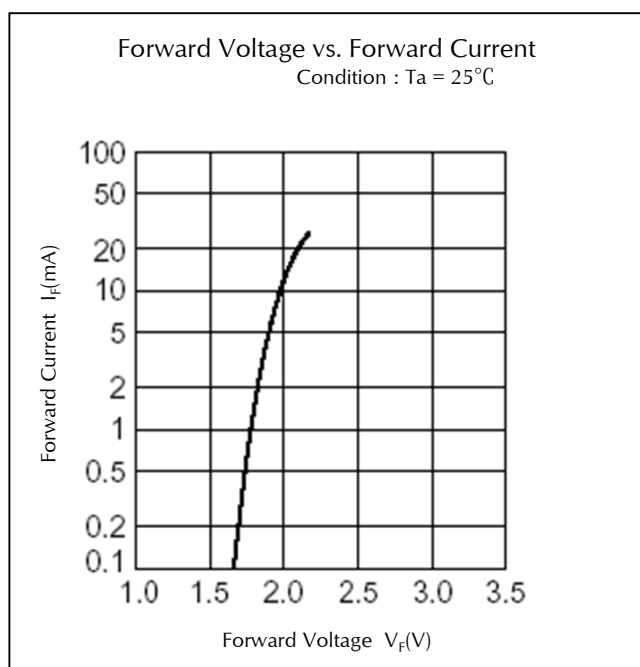
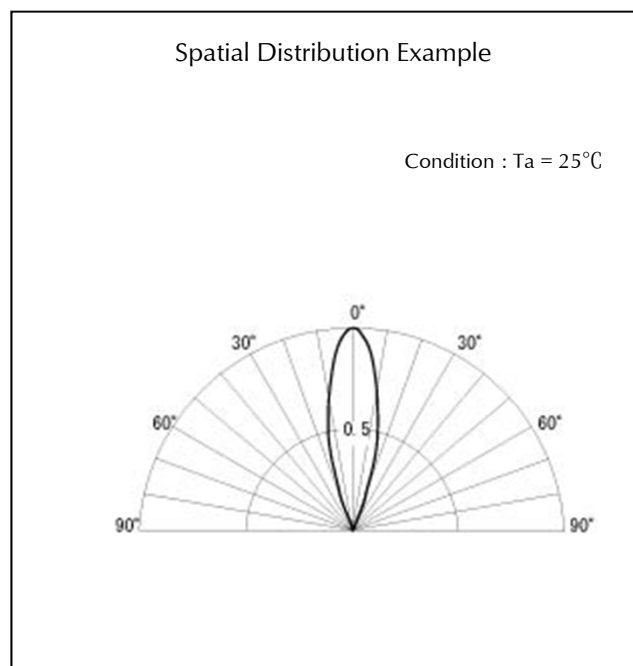
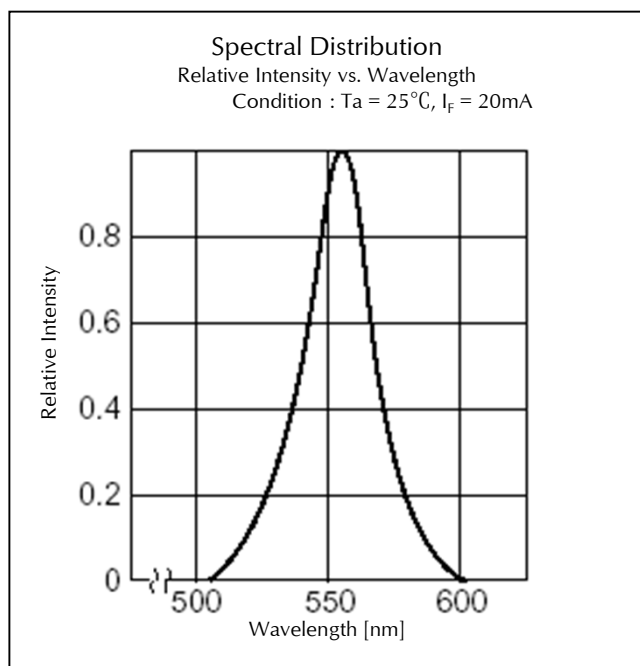
Luminous Intensity Rank

(Ta=25°C)

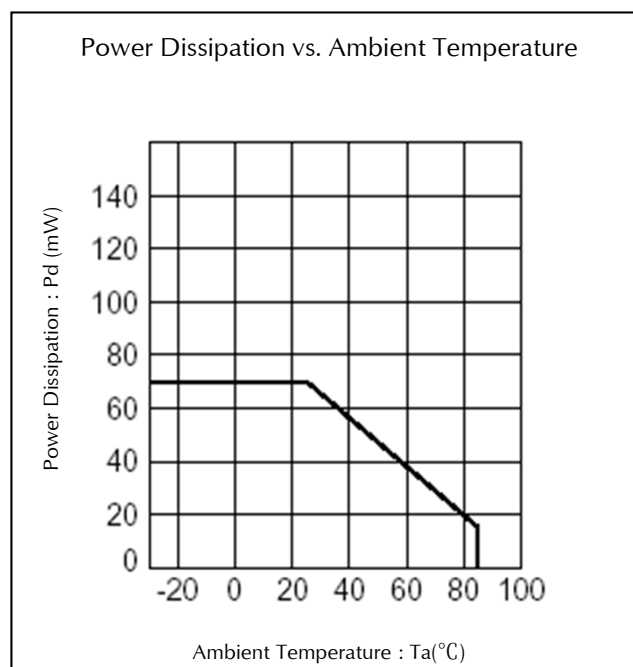
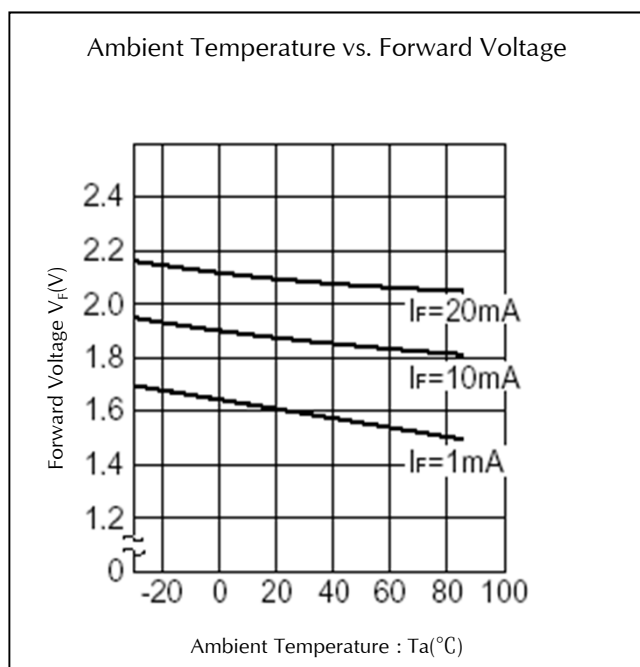
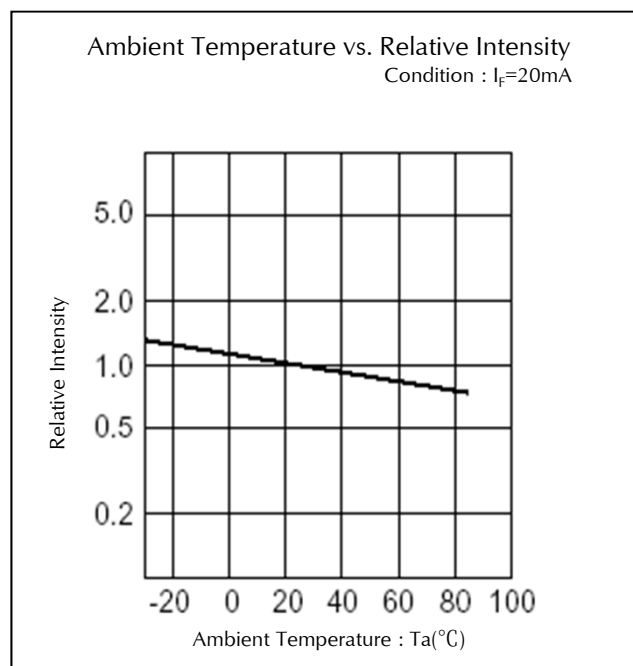
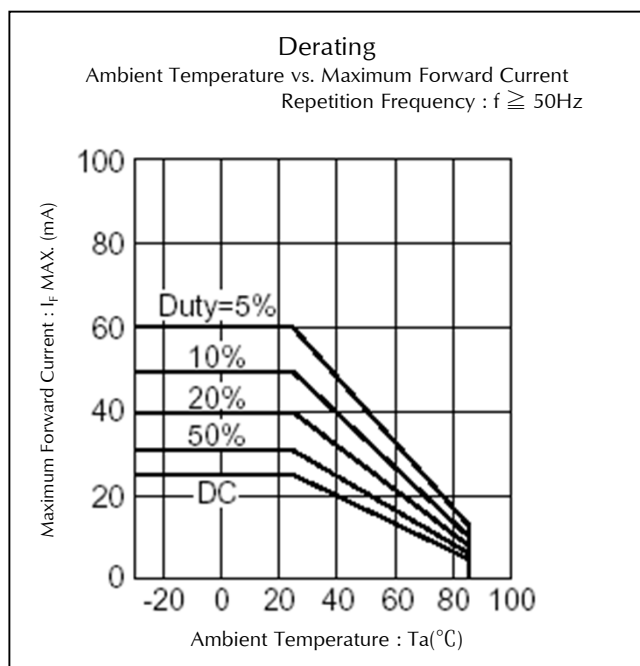
Rank	I_v (mcd)													
	MBG		MPG		MAY		MAA		MVR		BR		MPR	
	$I_f=20\text{mA}$		$I_f=20\text{mA}$		$I_f=20\text{mA}$		$I_f=20\text{mA}$		$I_f=20\text{mA}$		$I_f=20\text{mA}$		$I_f=10\text{mA}$	
	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.	MIN.	MAX.
A	20	40	50	100	40	80	50	100	50	100	60	120	5	10
B	28	56	70	140	56	112	70	140	70	140	84	168	7	14
C	40	80	100	200	80	160	100	200	100	200	120	240	10	20
D	56	112	140	280	112	224	140	280	140	280	168	336	14	28
E	80	-	200	-	160	-	200	-	200	-	240	-	20	-

※ Please contact our sales staff concerning rank designation.

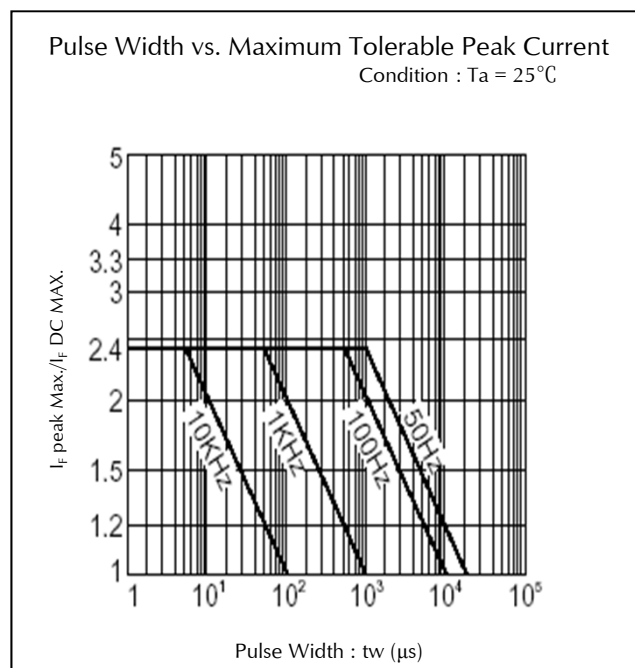
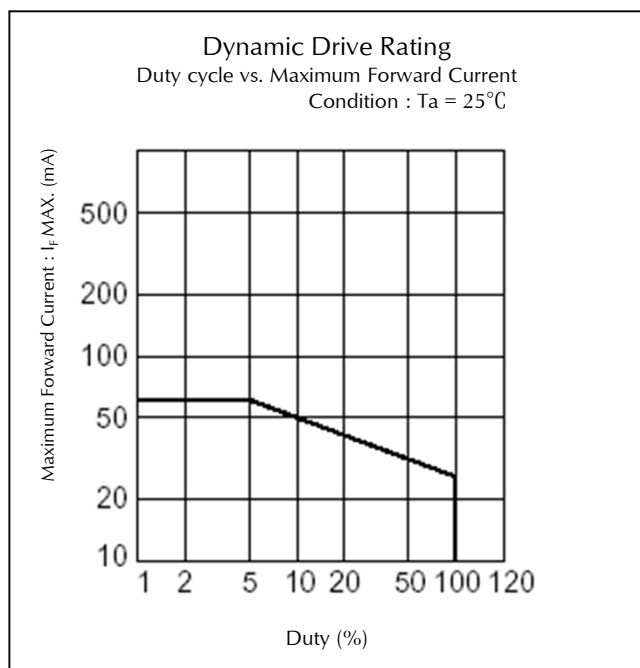
Technical Data(MBG)



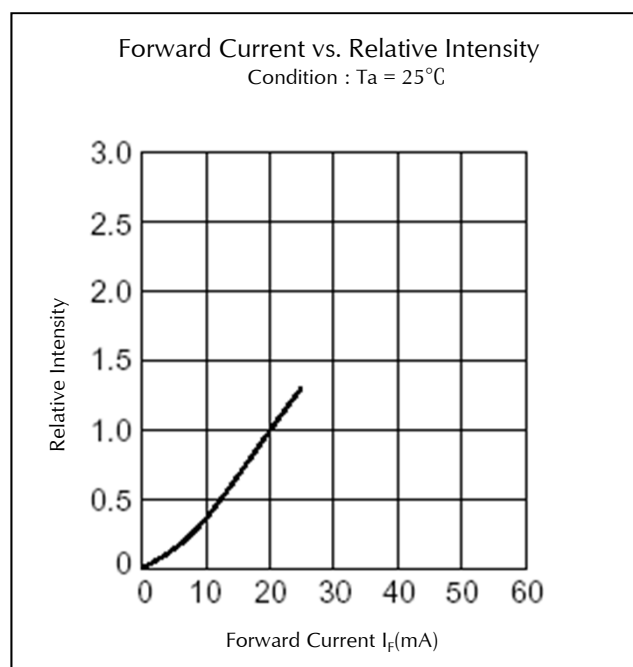
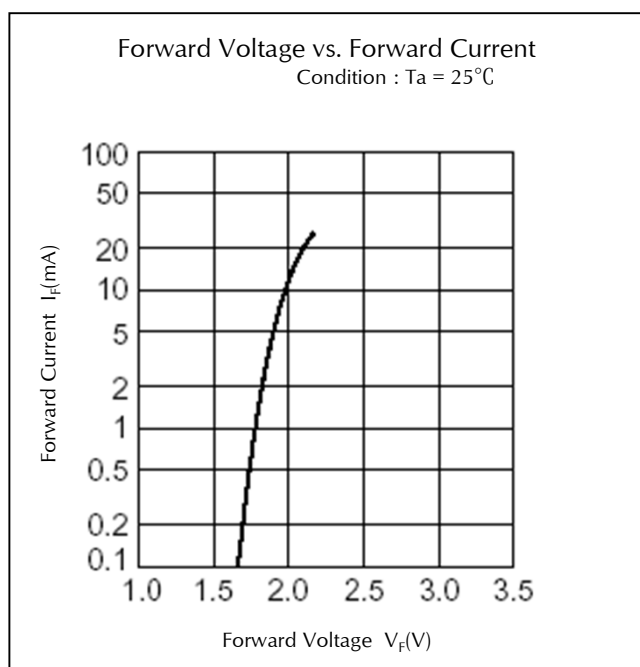
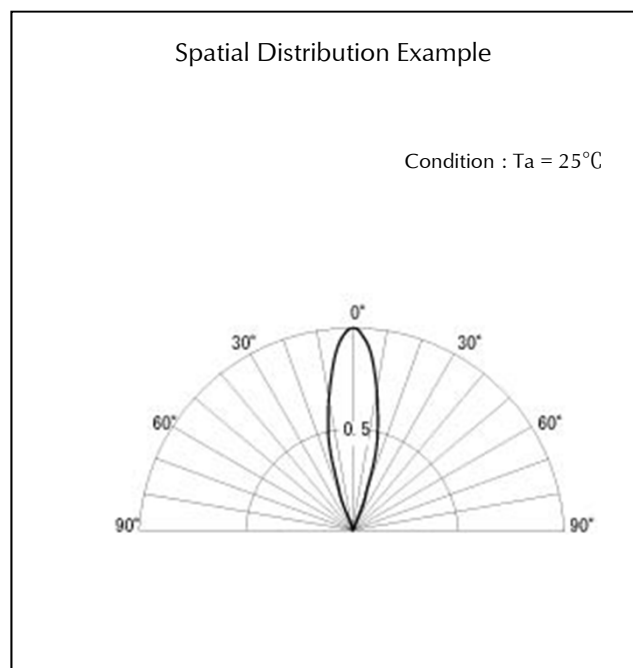
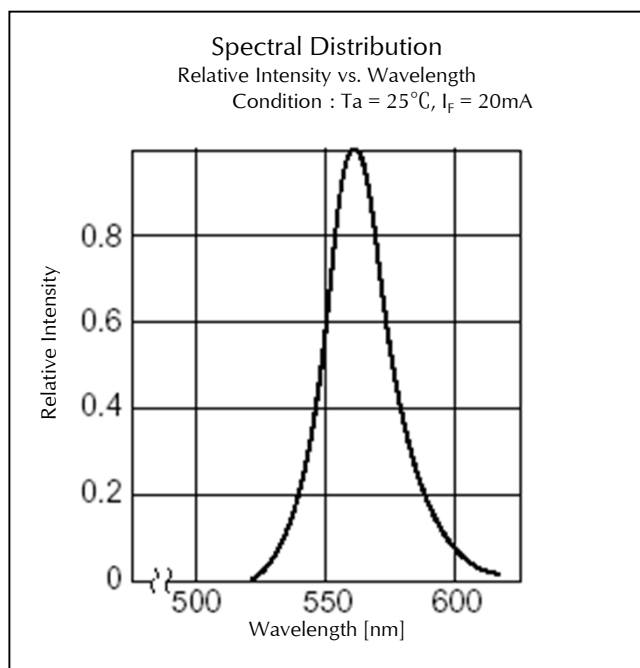
Technical Data(MBG)



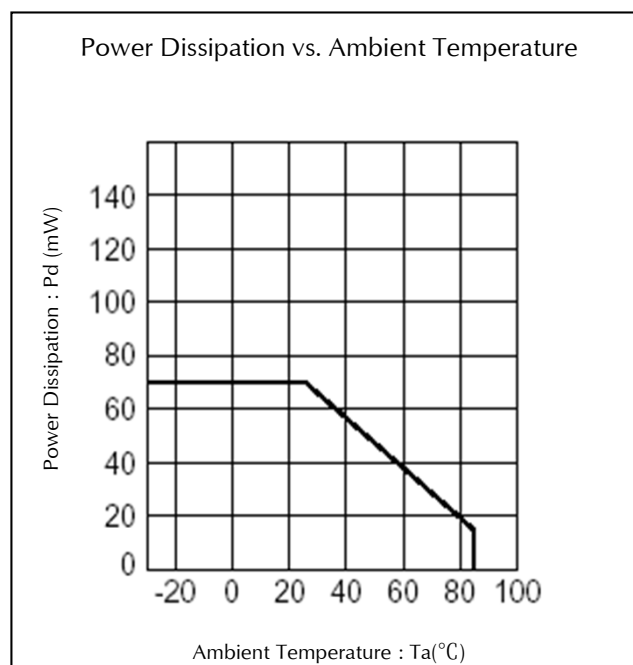
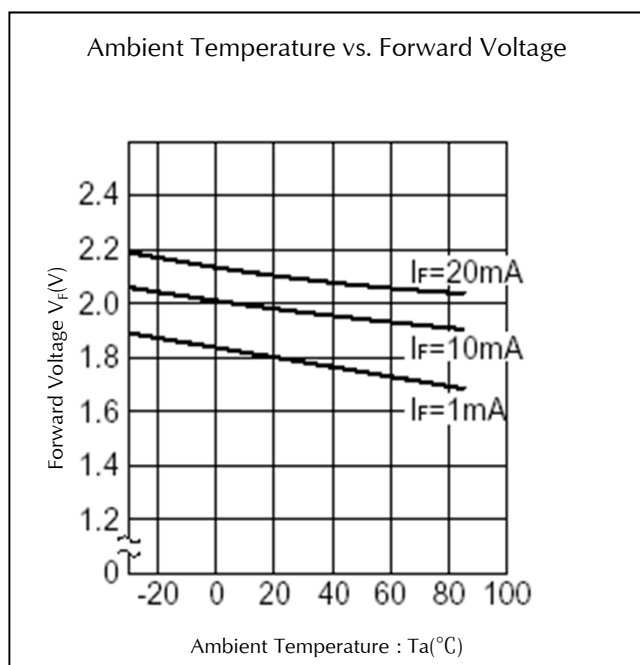
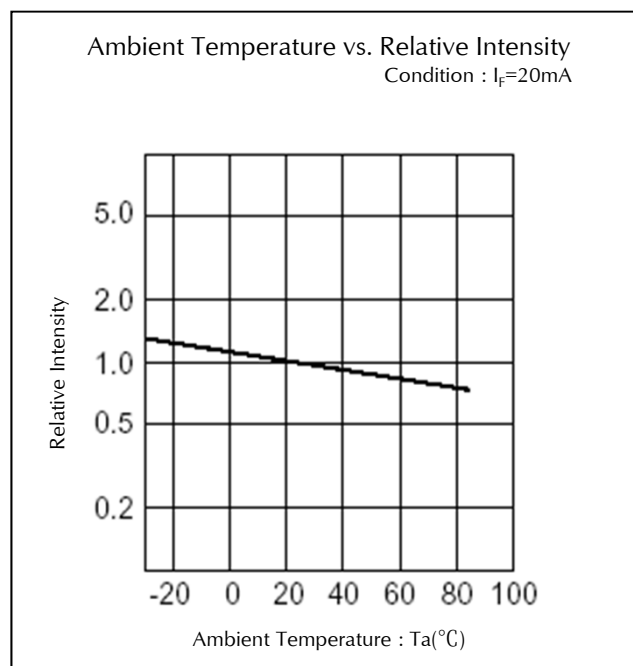
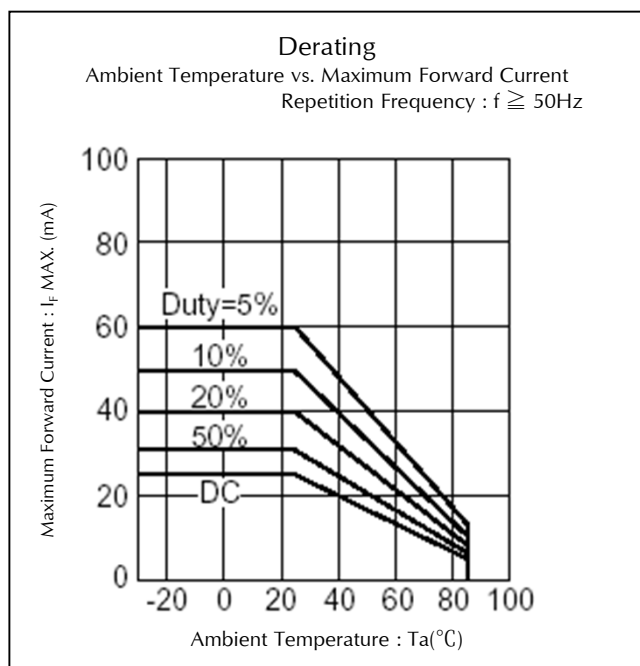
Technical Data(MBG)



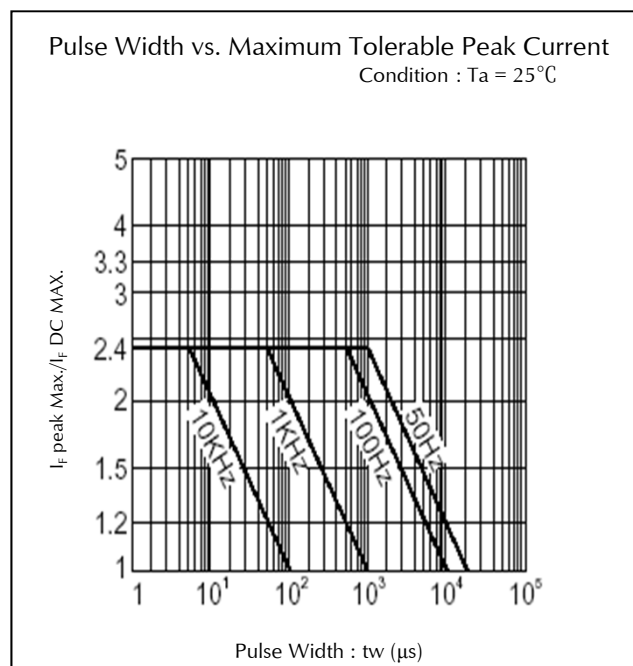
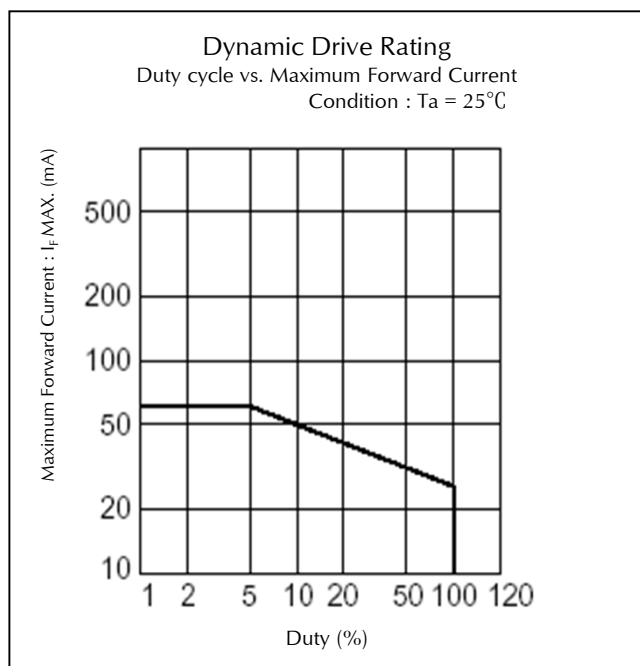
Technical Data(MPG)



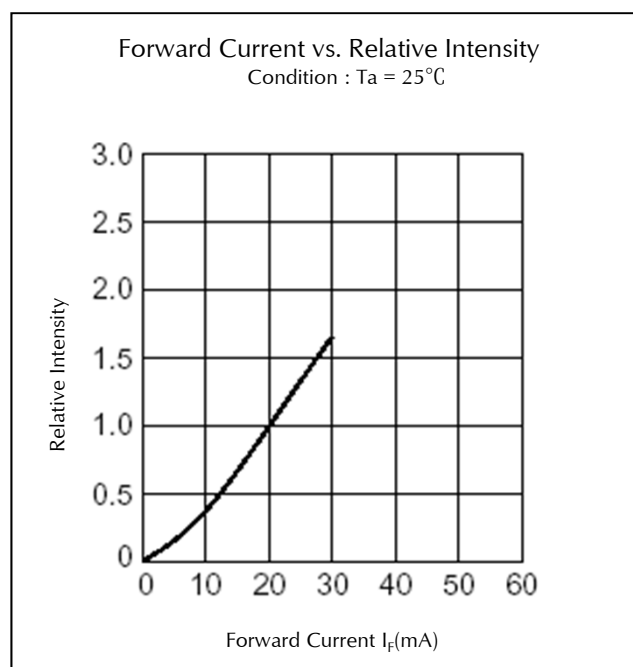
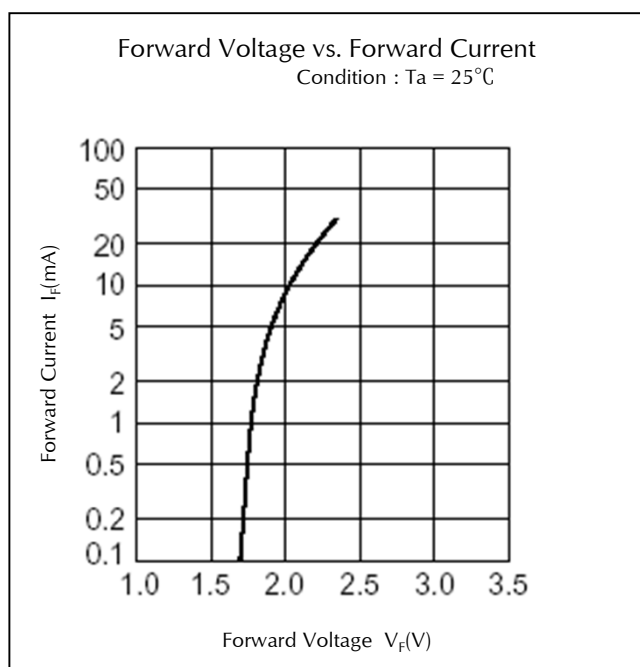
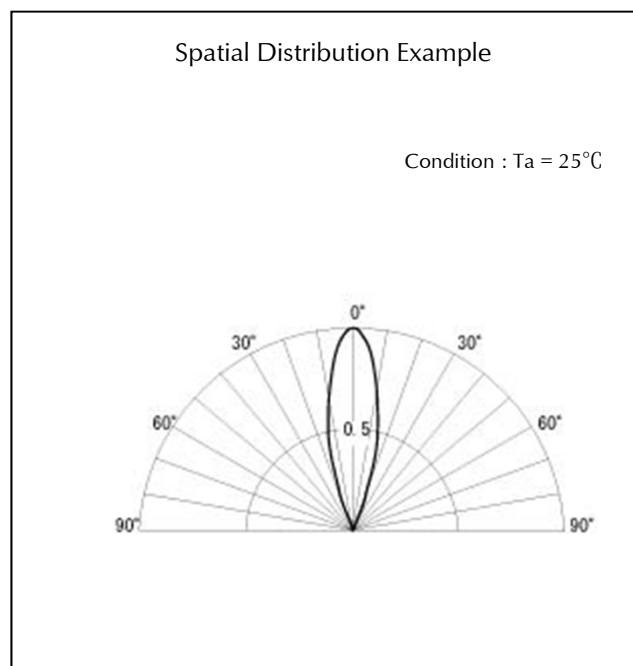
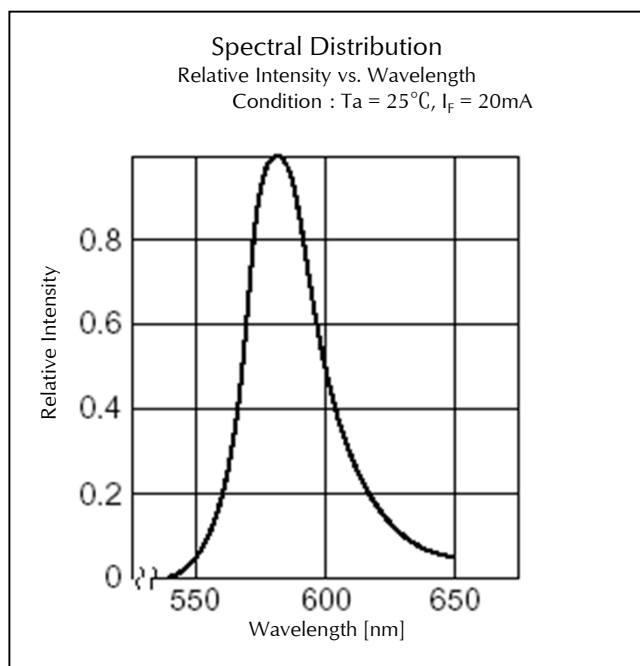
Technical Data(MPG)



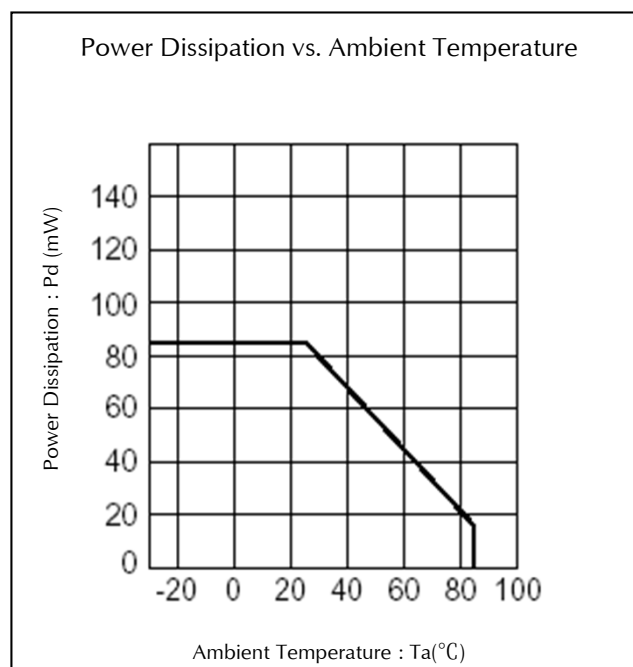
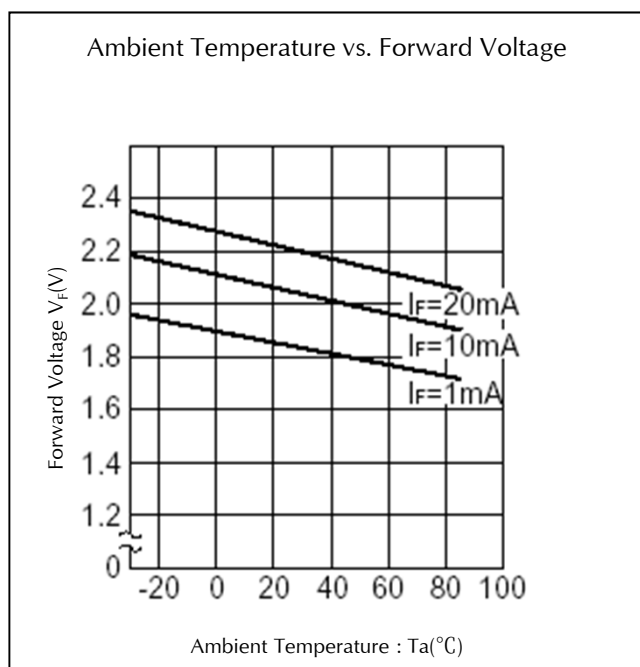
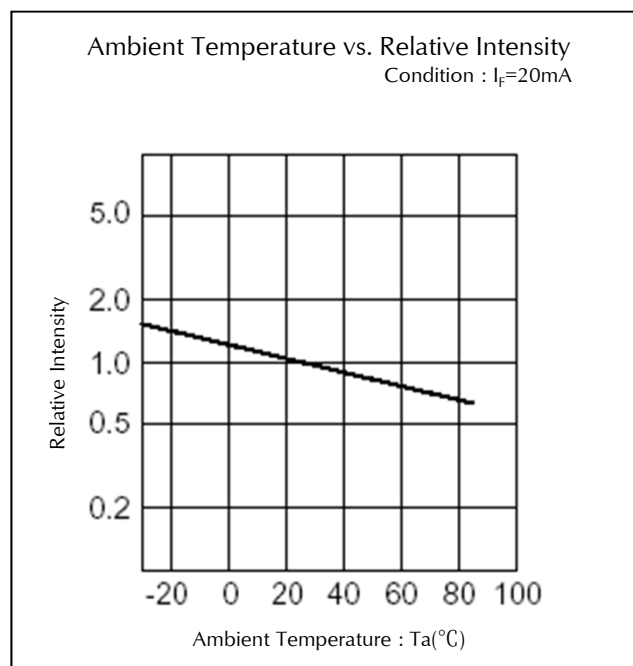
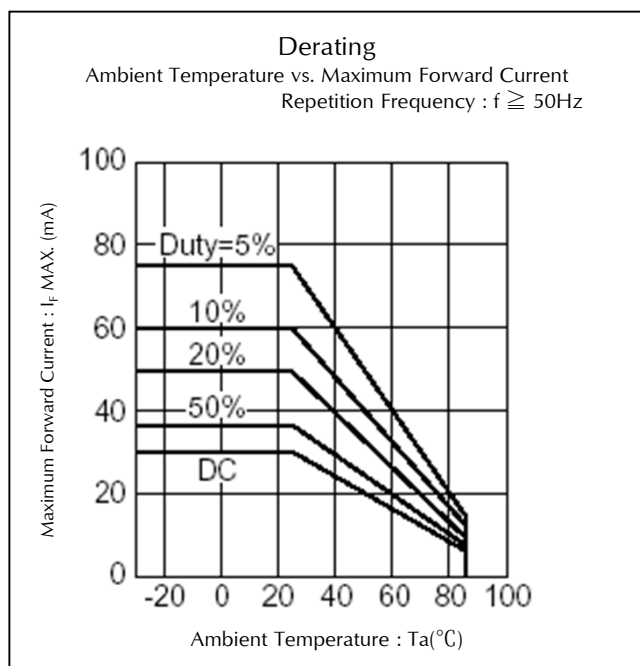
Technical Data(MPG)



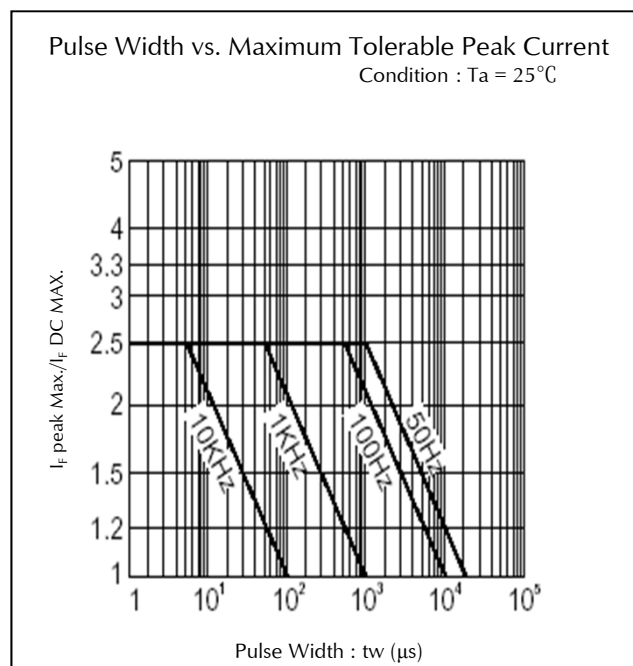
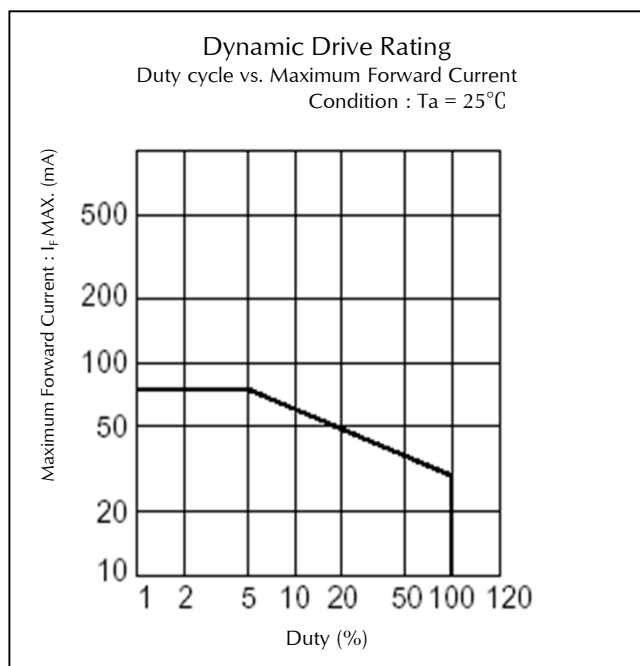
Technical Data(MAY)



Technical Data(MAY)

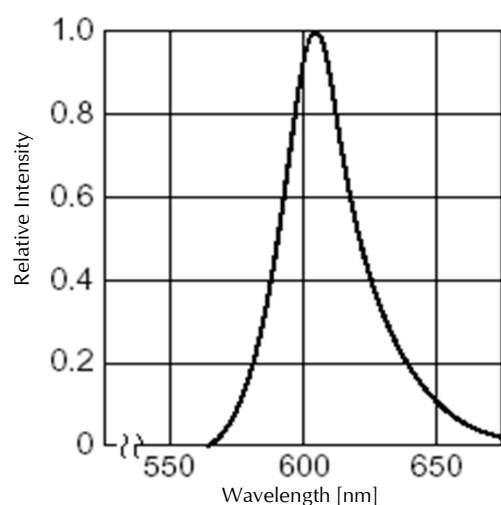


Technical Data(MAY)



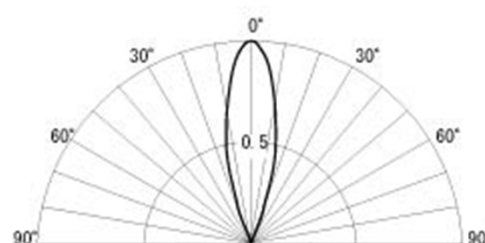
Technical Data(MAA)

Spectral Distribution
Relative Intensity vs. Wavelength
Condition : $T_a = 25^\circ\text{C}$, $I_F = 20\text{mA}$

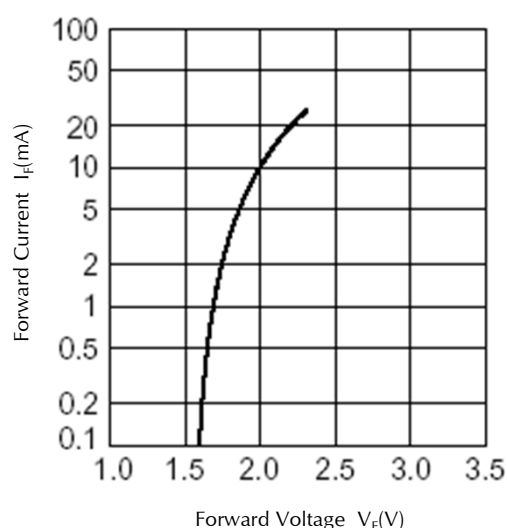


Spatial Distribution Example

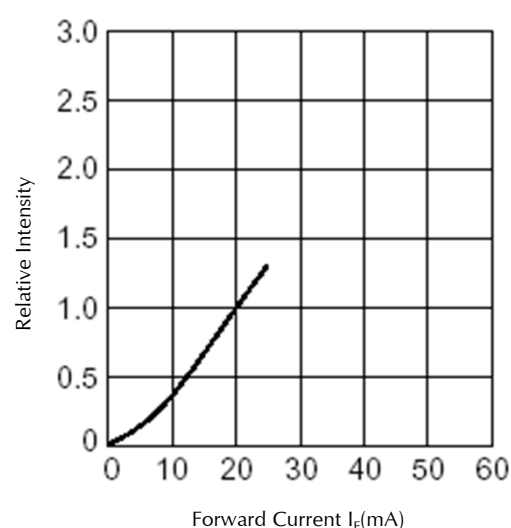
Condition : $T_a = 25^\circ\text{C}$



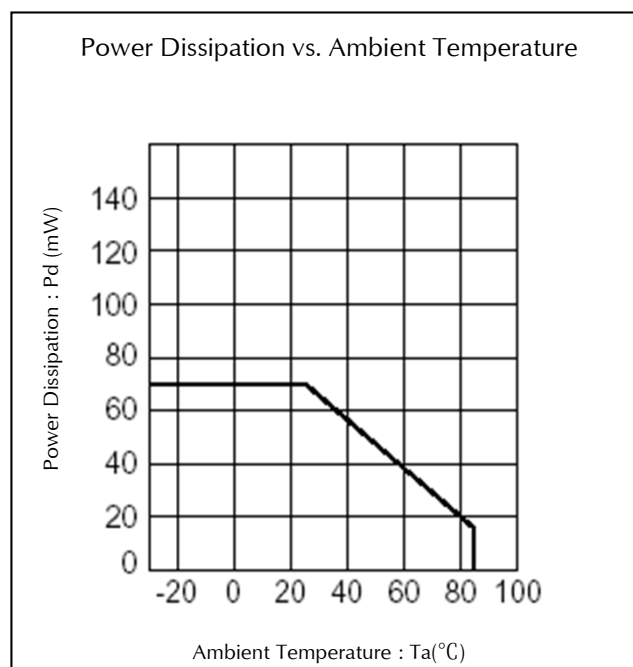
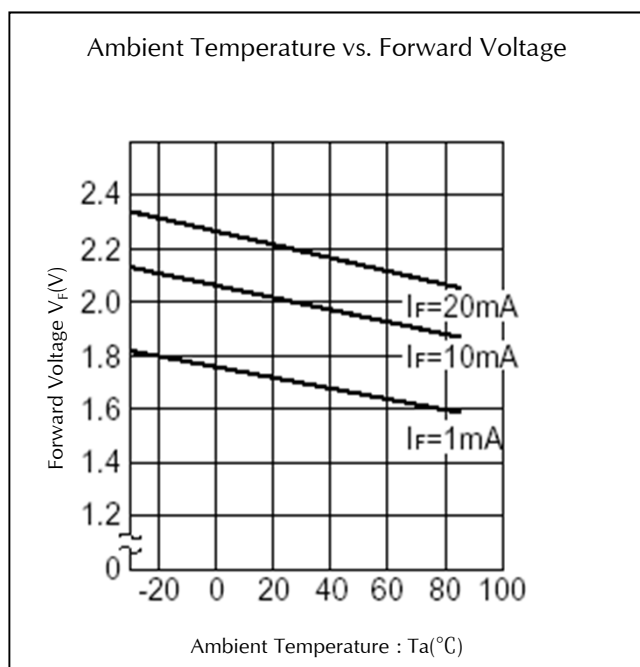
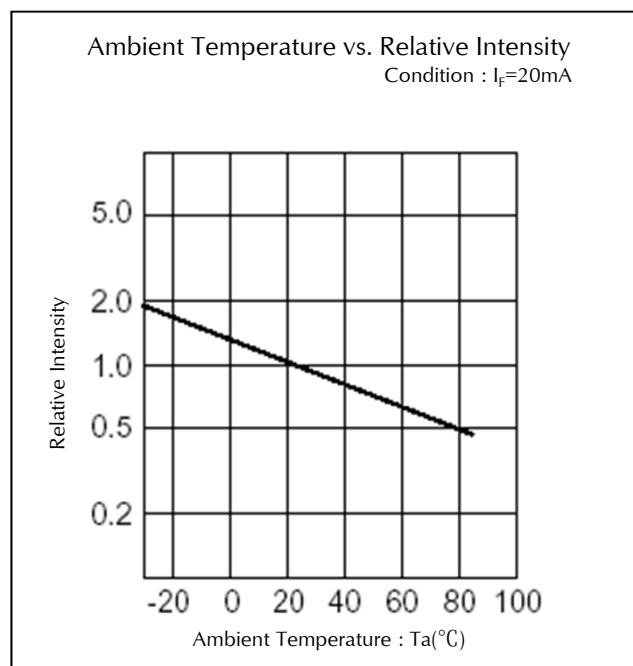
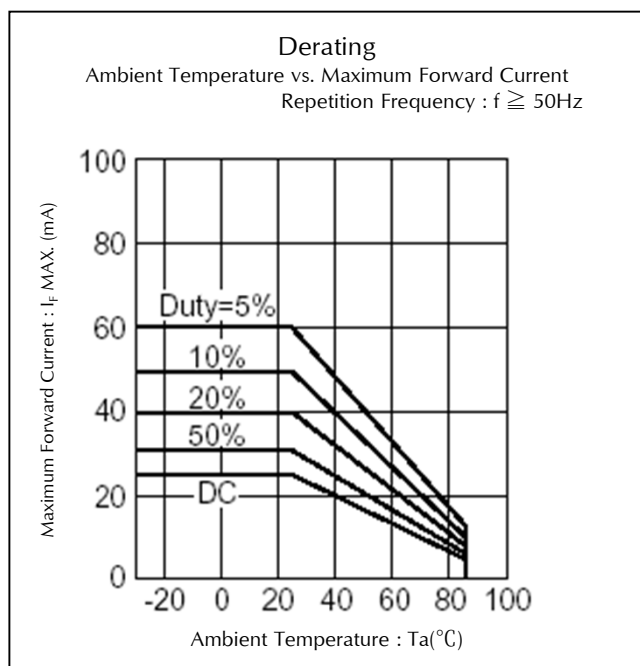
Forward Voltage vs. Forward Current
Condition : $T_a = 25^\circ\text{C}$



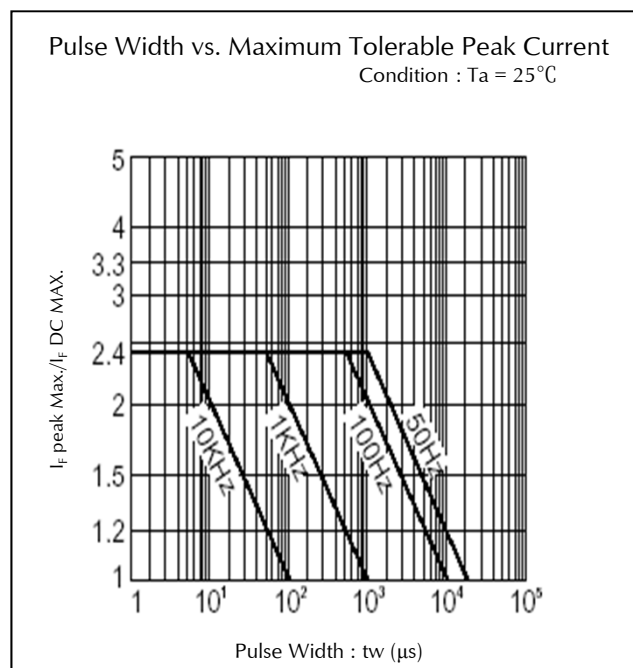
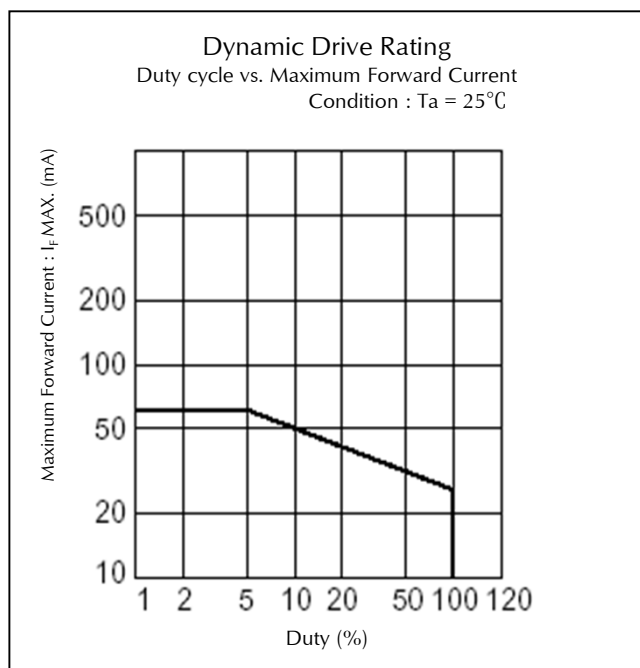
Forward Current vs. Relative Intensity
Condition : $T_a = 25^\circ\text{C}$



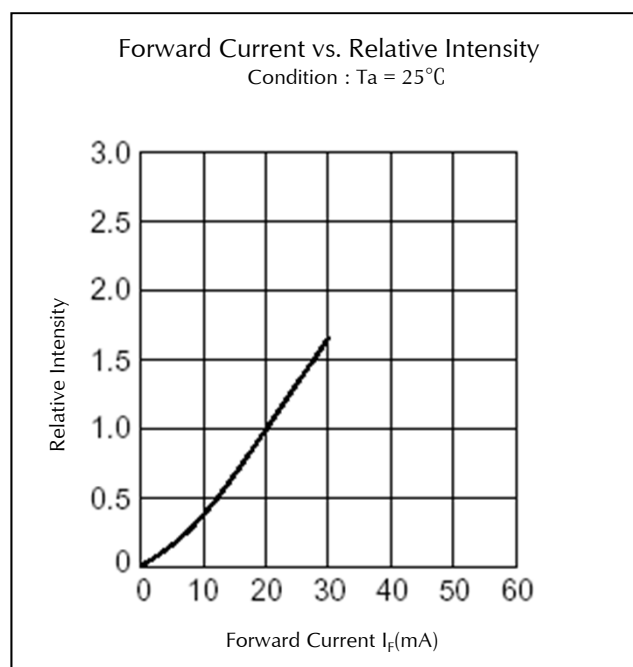
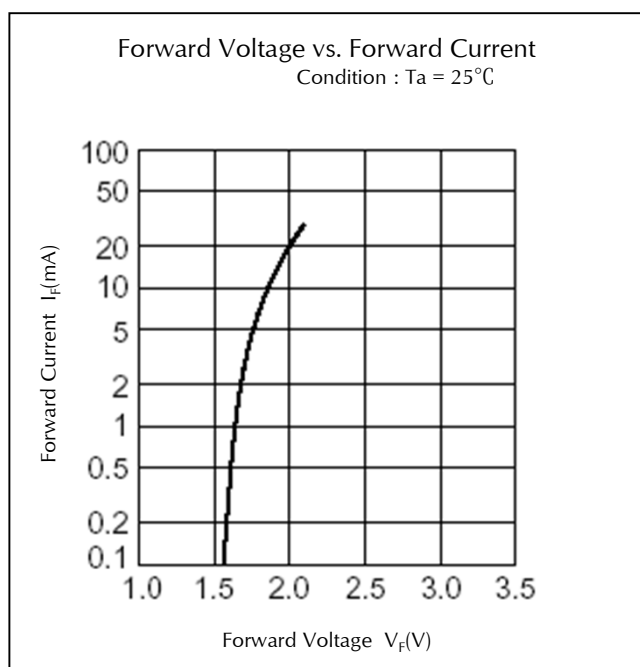
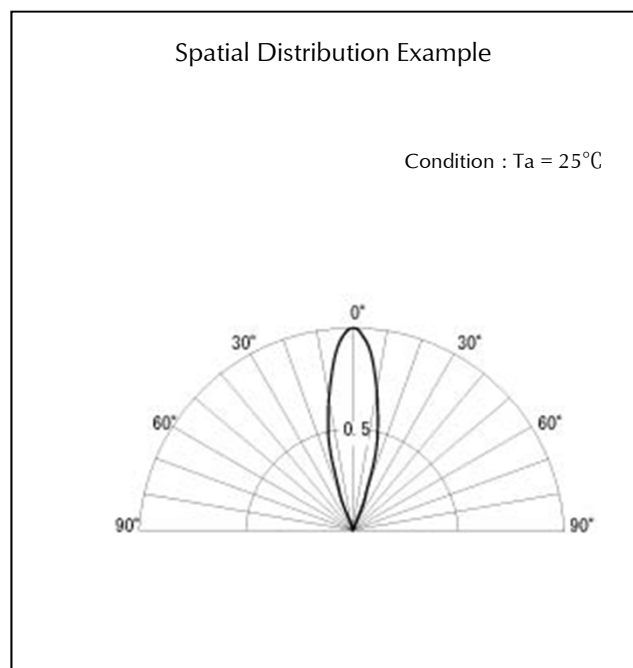
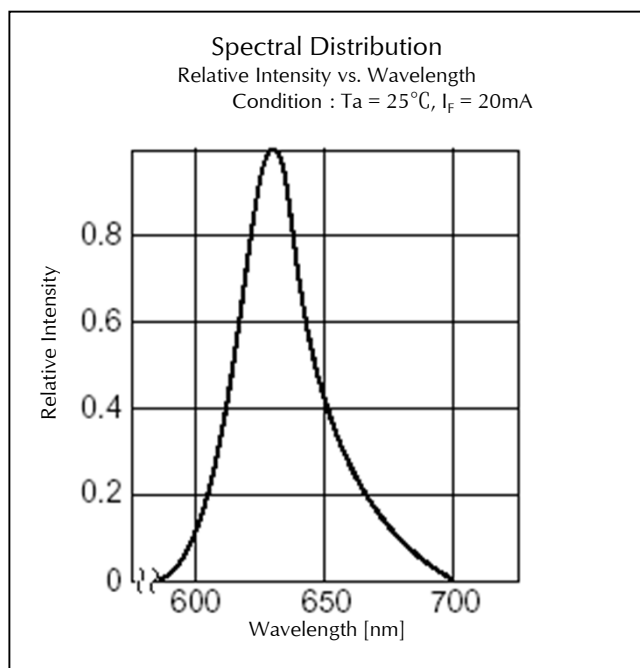
Technical Data(MAA)



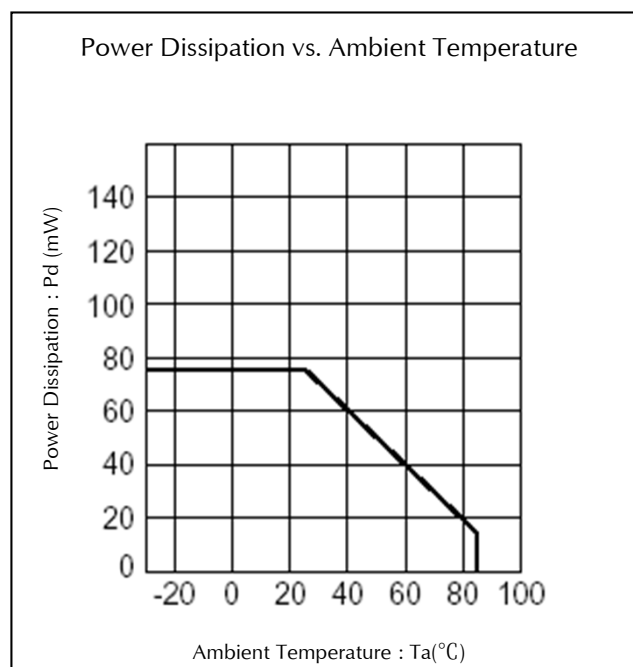
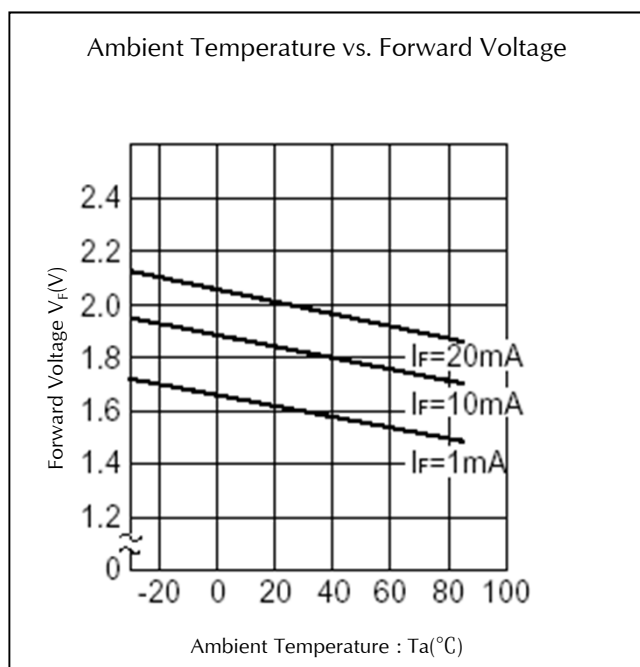
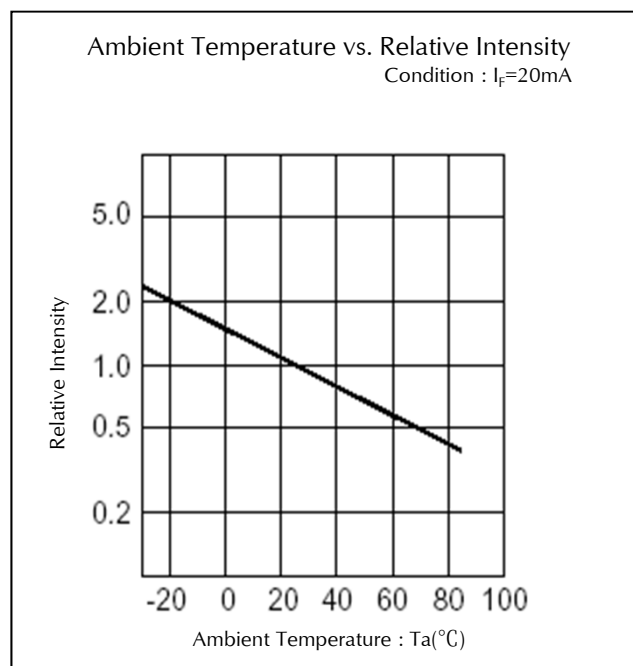
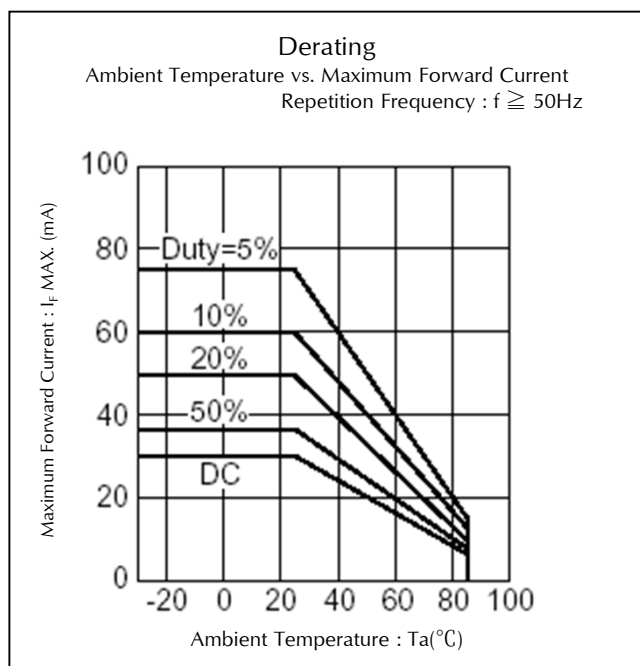
Technical Data(MAA)



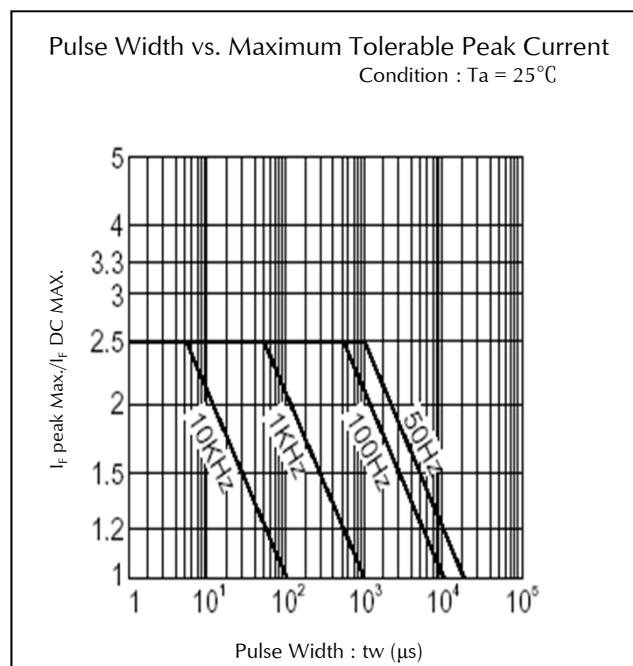
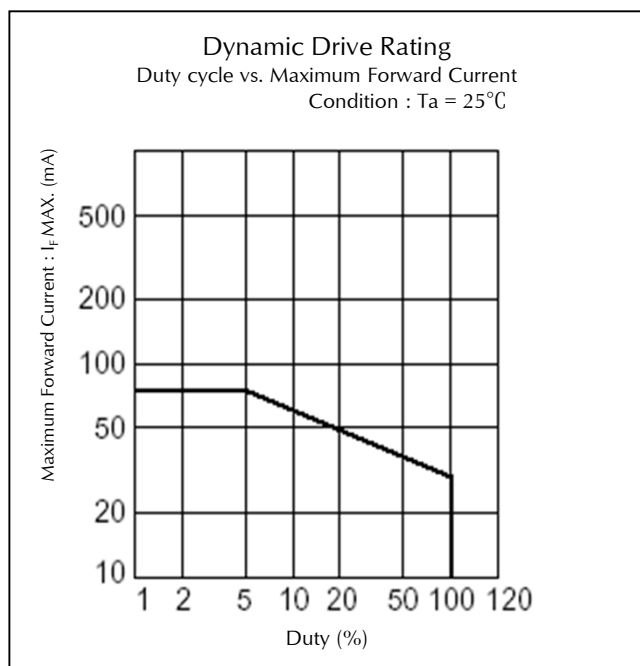
Technical Data(MVR)



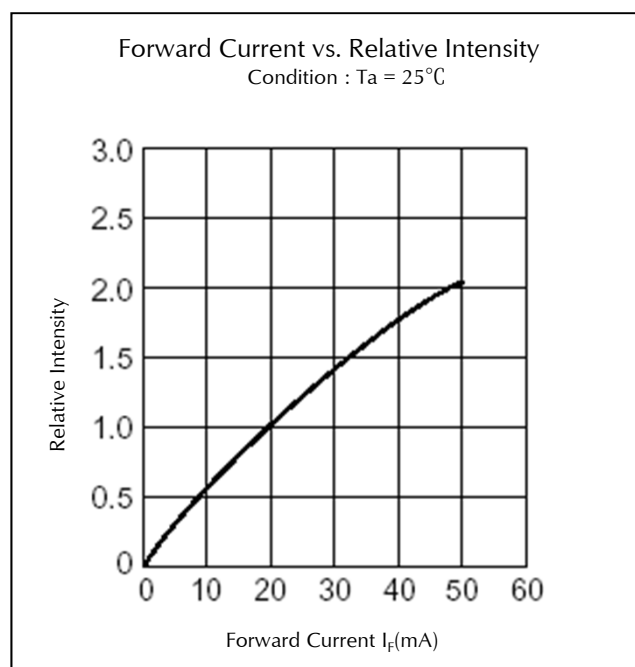
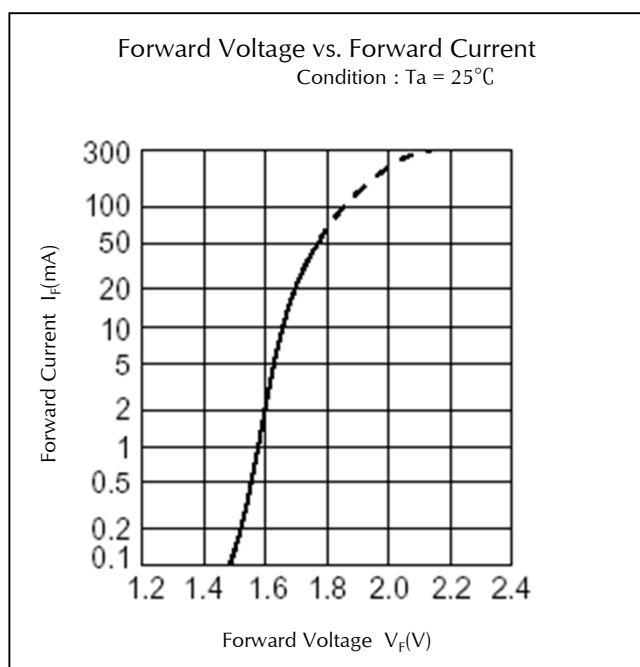
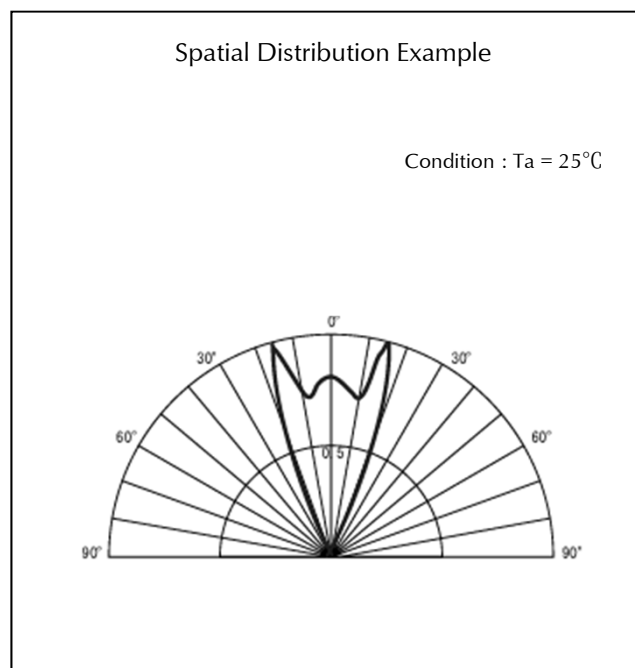
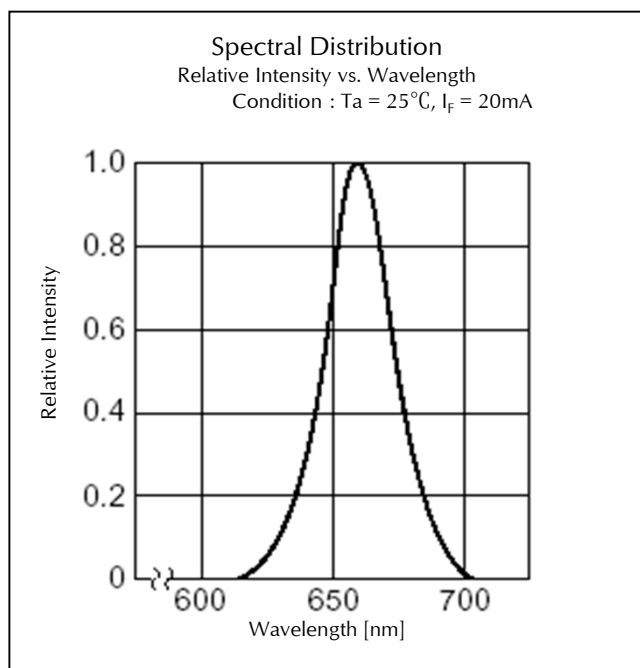
Technical Data(MVR)



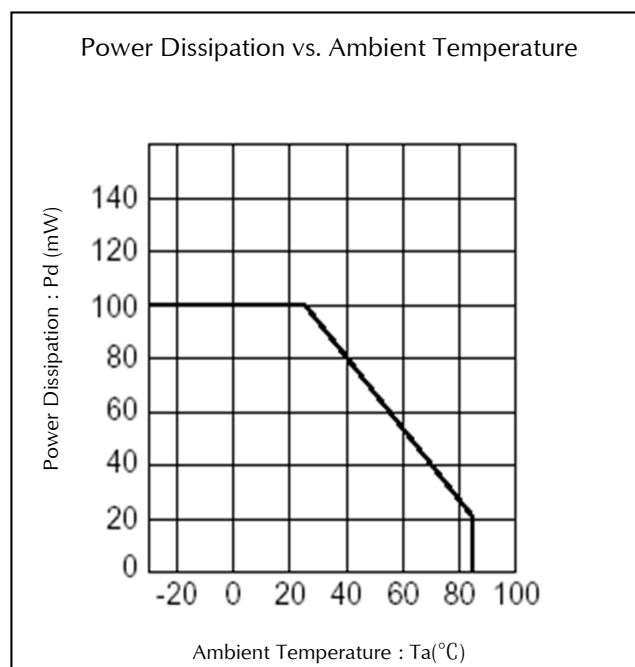
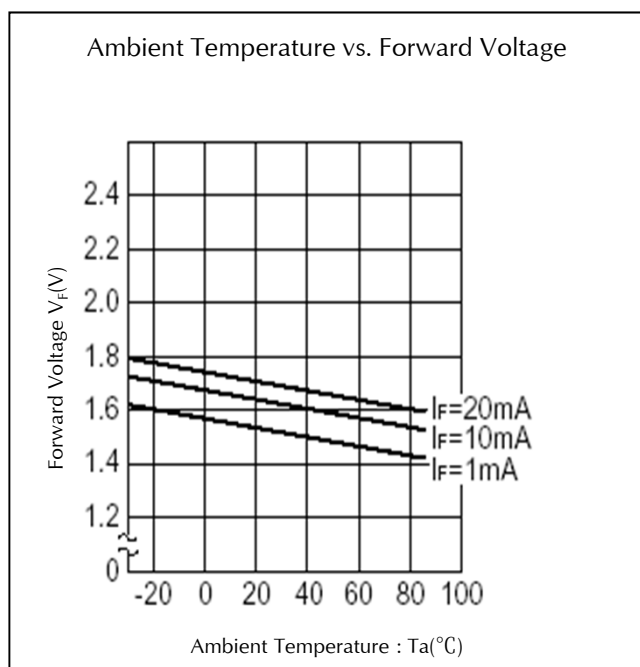
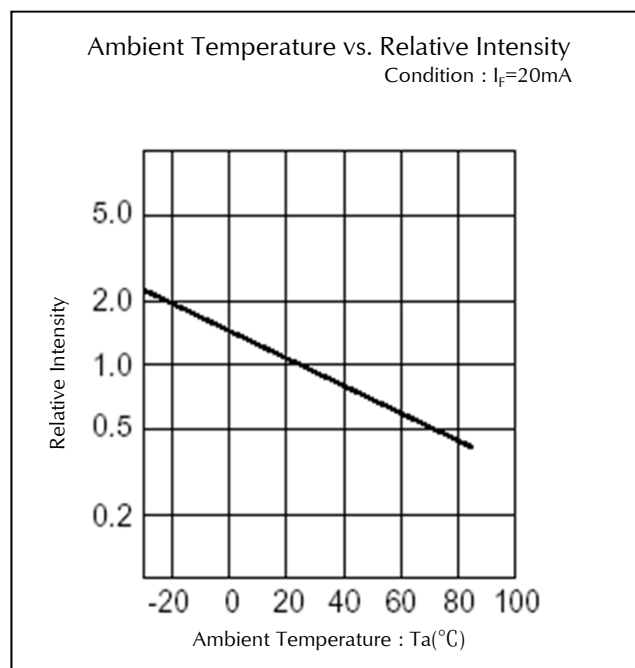
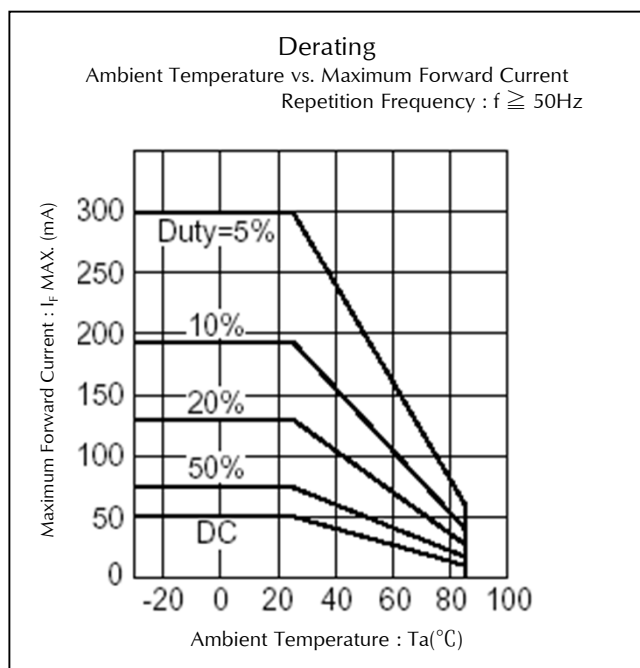
Technical Data(MVR)



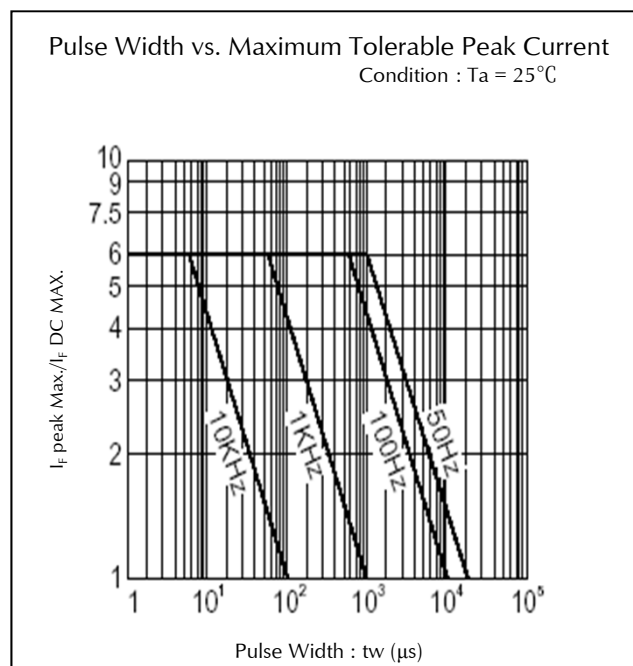
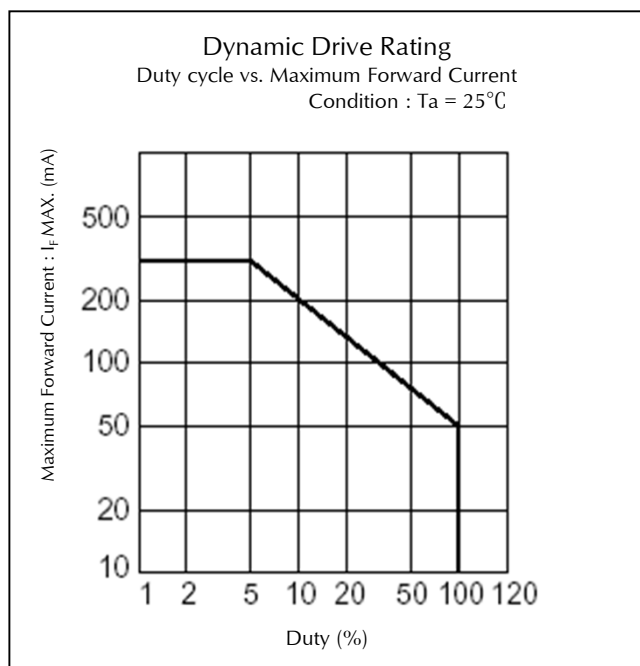
Technical Data(BR)



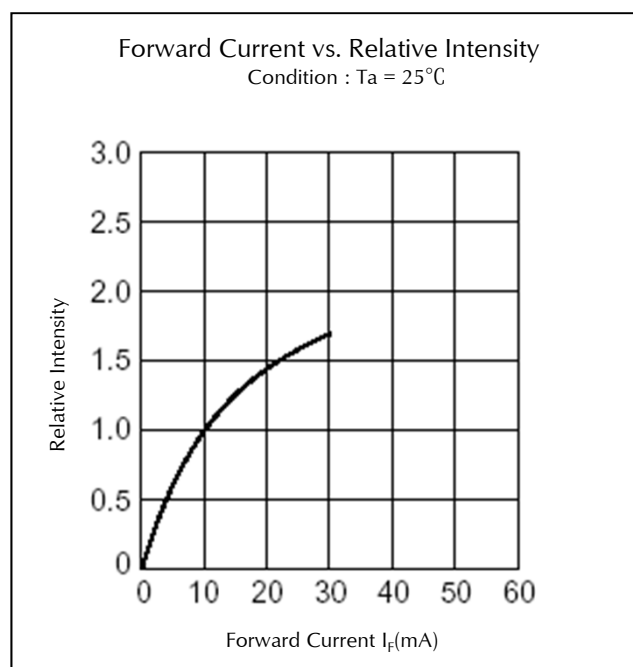
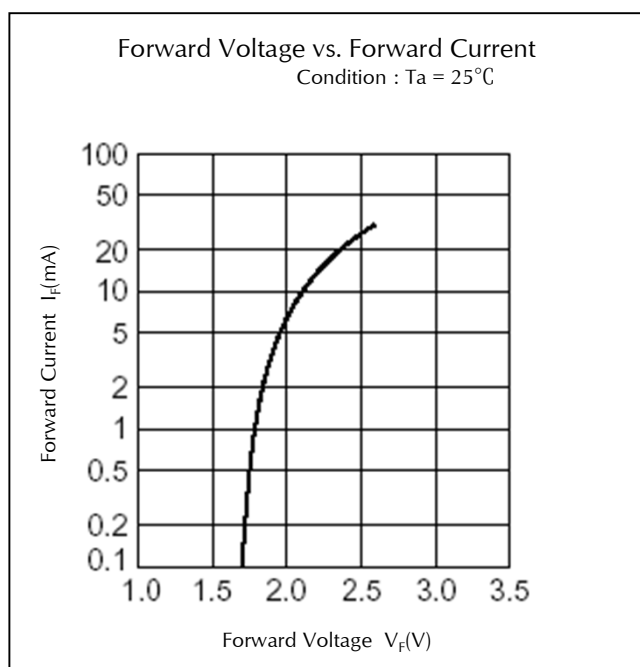
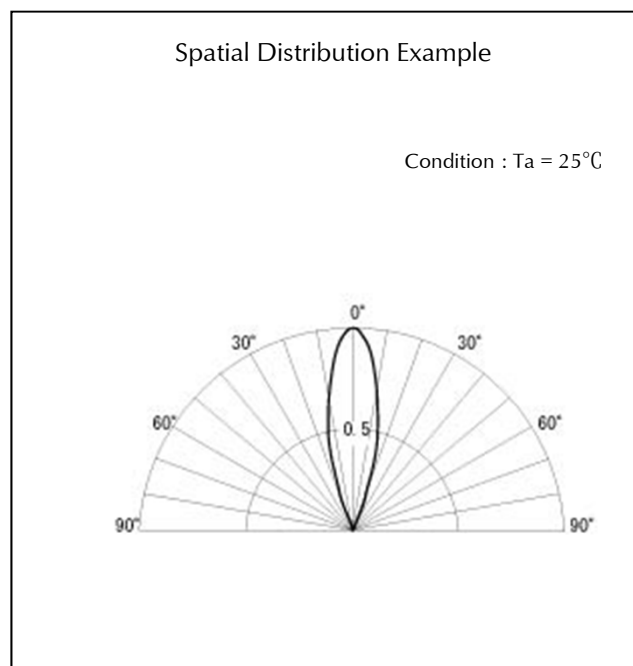
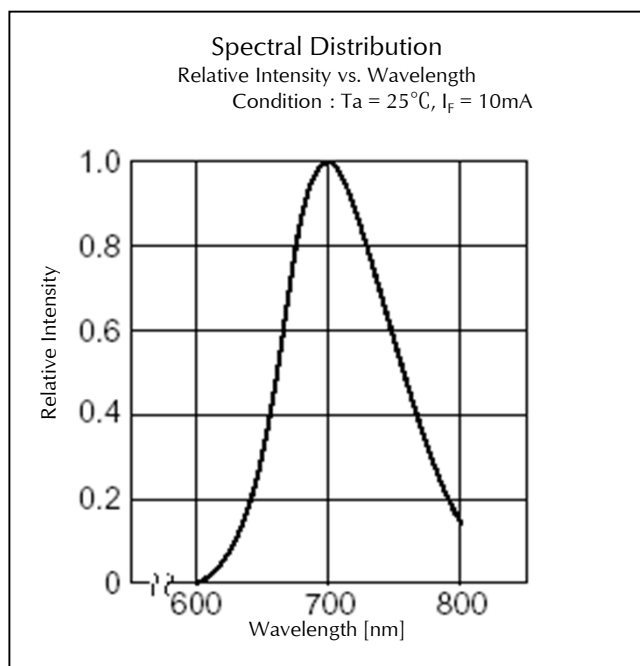
Technical Data(BR)



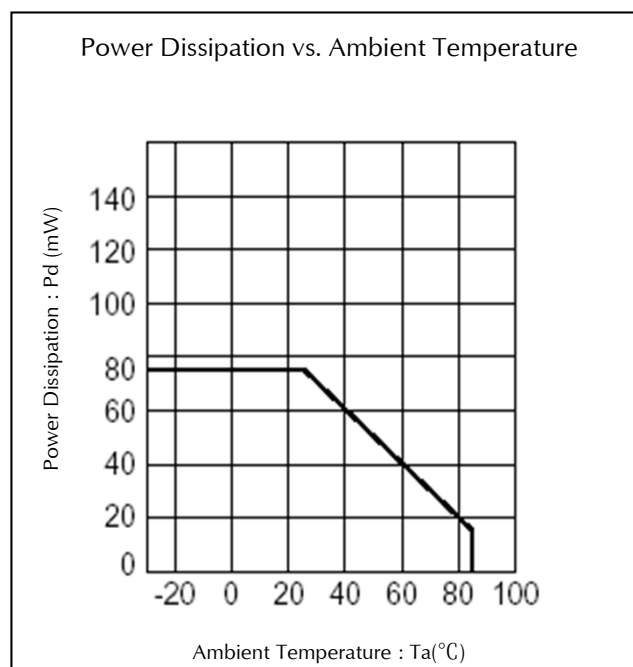
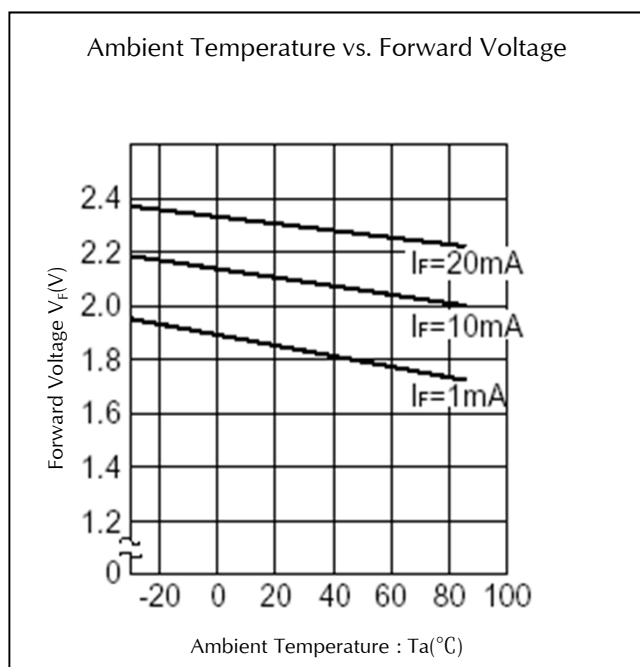
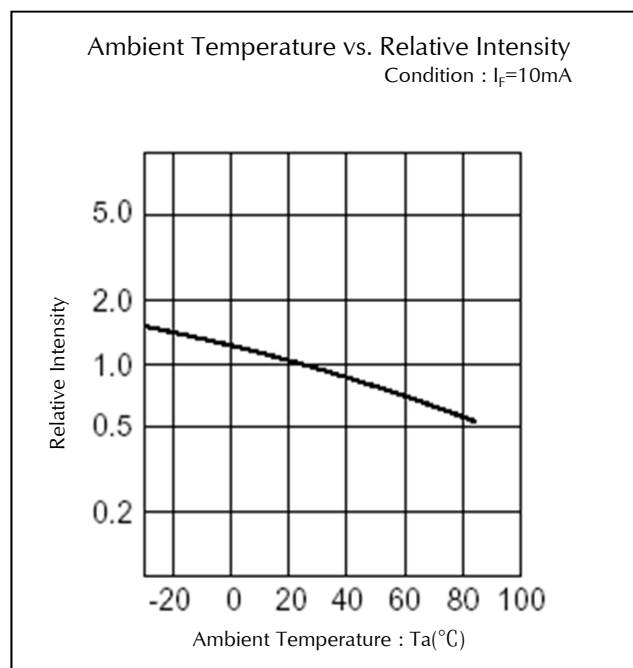
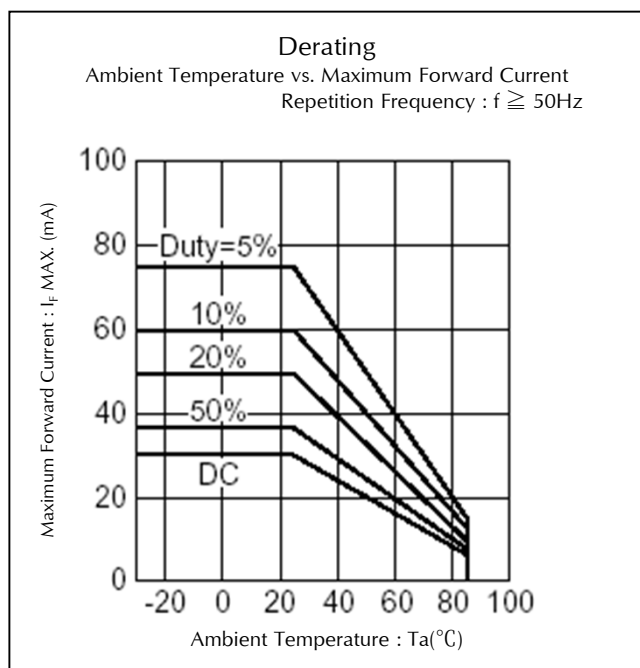
Technical Data(BR)



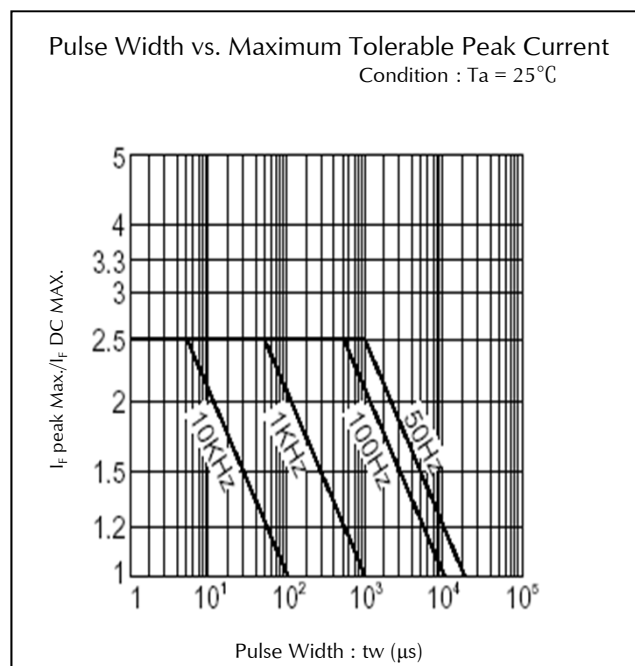
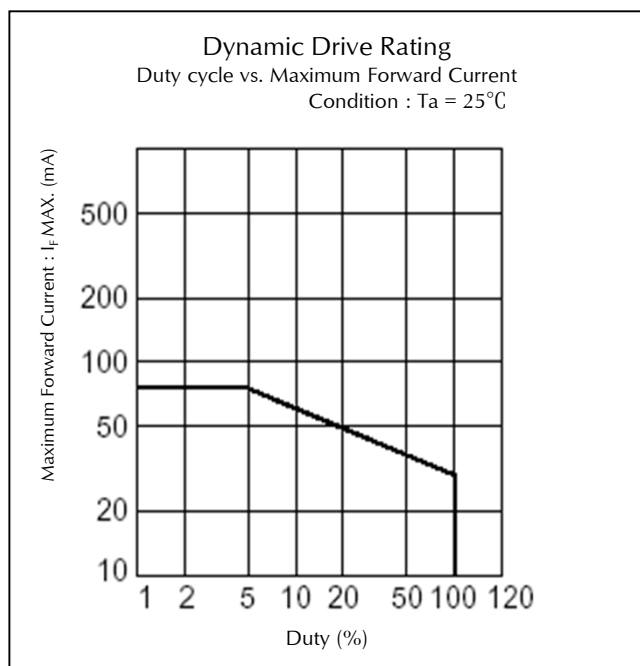
Technical Data(MPR)



Technical Data(MPR)



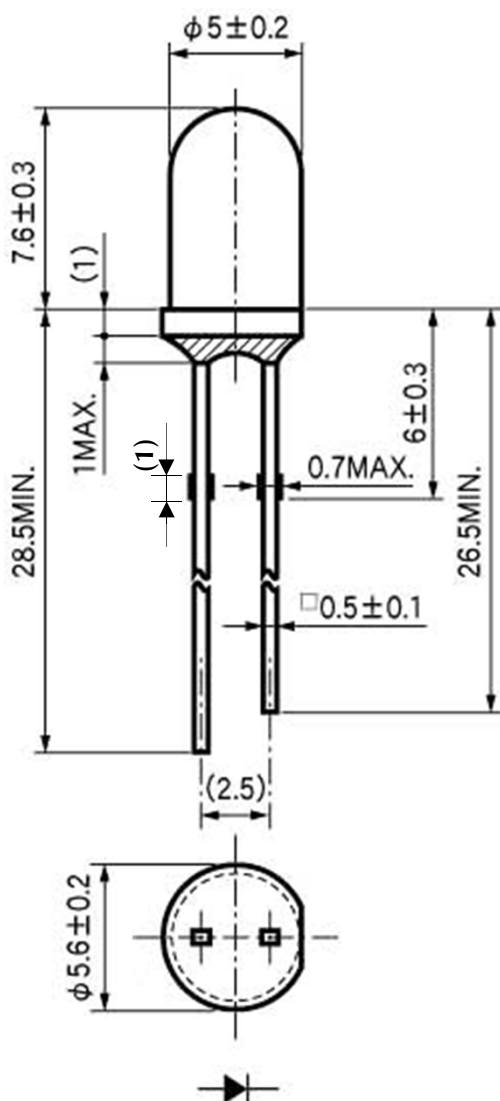
Technical Data(MPR)



Package Dimensions

(Unit: mm)

Mass : (0.34)g



TTW (Through The Wave) soldering Conditions

Pre-heating	100 °C	(MAX.)
Solder Bath Temp.	265°C	(MAX.)
Dipping Time	5 s	(MAX.)

- 1) The dip soldering process shall be 2 times maximum.
- 2) The product shall be cooled to room temp. before the second dipping process.

※The detail is described to LED and Photodetector handling precautions of home page:
"Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.

Manual Soldering Conditions

Iron tip temp.	360°C	(MAX.)
Soldering time and frequency	3 s	(MAX.)
	2 times	(MAX.)

※The detail is described to LED and Photodetector handling precautions of home page:
"Mounting through-hole Type Devices" and "Soldering", and use it after the confirmation, please.

Reliability Testing Result

Reliability Testing Result	Applicable Standard	Testing Conditions	Duration	Failure
Room Temp. Operating Life	EIAJ ED-4701/100(101)	Ta = 25°C, If = Maximum Rated Current	1,000 h	0/25
Resistance to Soldering Heat	EIAJ ED-4701/300(302)	260±5°C, 3mm from package base	10s	0/25
Temperature Cycling	EIAJ ED-4701/100(105)	Minimum Rated Storage Temperature(30min) ~Normal Temperature(15min) ~Maximum Rated Storage Temperature(30min) ~Normal Temperature(15min)	5 cycles	0/25
Wet High Temp. Storage Life	EIAJ ED-4701/100(103)	Ta = 60±2°C, RH = 90±5%	1,000 h	0/25
High Temp. Storage Life	EIAJ ED-4701/200(201)	Ta = Maximum Rated Storage Temperature	1,000 h	0/25
Low Temp. Storage Life	EIAJ ED-4701/200(202)	Ta = Minimum Rated Storage Temperature	1,000 h	0/25
Lead Tension	EIAJ ED-4701/400(401)	10N, 1time (□0.4 and Flat Package : 5N)	10s	0/10
Vibration, Variable Frequency	EIAJ ED-4701/400(403)	98.1m/s ² (10G), 100 ~ 2KHz sweep for 20min., XYZ each direction	2 h	0/10

Failure Criteria

Items	Symbols	Conditions	Failure criteria
Luminous Intensity	Iv	If Value of each product Luminous Intensity	Testing Min. Value < Spec. Min. Value x 0.5
Forward Voltage	V _F	If Value of each product Forward Voltage	Testing Max. Value ≥ Spec. Max. Value x 1.2
Reverse Current	I _R	V _R = Maximum Rated Reverse Voltage V	Testing Max. Value ≥ Spec. Max. Value x 2.5
Cosmetic Appearance	-	-	Occurrence of notable decoloration, deformation and cracking

Special Notice to Customers Using the Products and Technical Information Shown in This Data Sheet

- 1) The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.
- 2) For the purpose of product improvement, the specifications, characteristics and technical data described in the data sheets are subject to change without prior notice. Therefore it is recommended that the most updated specifications be used in your design.
- 3) When using the products described in the data sheets, please adhere to the maximum ratings for operating voltage, heat dissipation characteristics, and other precautions for use. We are not responsible for any damage which may occur if these specifications are exceeded.
- 4) The products that have been described to this catalog are manufactured so that they will be used for the electrical instrument of the benchmark (OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument).
The application of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. needs a high reliability and safety, and the breakdown and the wrong operation might influence the life or the human body. Please consult us beforehand if you plan to use our product for the usages of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. except OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument.
- 5) In order to export the products or technologies described in this data sheet which are under the "Foreign Exchange and Foreign Trade Control Law," it is necessary to first obtain an export permit from the Japanese government.
- 6) No part of this data sheet may be reprinted or reproduced without prior written permission from Stanley Electric Co., Ltd.
- 7) The most updated edition of this data sheet can be obtained from the address below:
<http://www.stanley-components.com>